

To our customers,

Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: <http://www.renesas.com>

April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (<http://www.renesas.com>)

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EOL Product

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Renesas Technology Home Page: <http://www.renesas.com>

Renesas Technology Corp.
Customer Support Dept.
April 1, 2003

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2SC4499(L)/(S)

Silicon NPN Triple Diffused

RENESAS

ADE-208-893 (Z)
1st. Edition
September 2000

Application

High speed and high voltage switching

Outline

DPAK



S Type



L Type

- 1. Base
- 2. Collector
- 3. Emitter
- 4. Collector

Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Collector to base voltage	V_{CBO}	500	V
Collector to emitter voltage	V_{CEO}	400	V
Emitter to base voltage	V_{EBO}	10	V
Collector current	I_C	0.5	A
Collector peak current	$I_{C(peak)}$	1.0	A
Collector power dissipation	P_C	0.75	W
	P_C^{*1}	10	
Junction temperature	T_j	150	°C
Storage temperature	T_{stg}	-55 to +150	°C

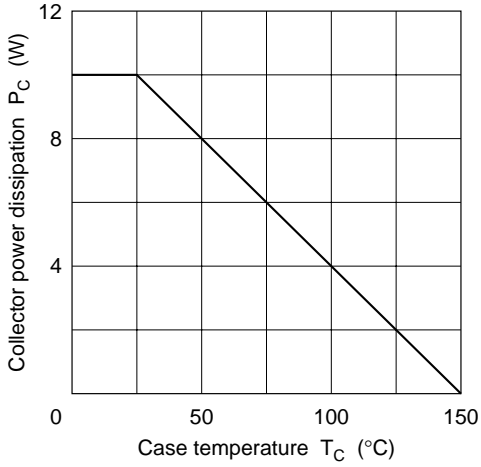
Note: 1. Value at $T_C = 25^\circ\text{C}$.

Electrical Characteristics (Ta = 25°C)

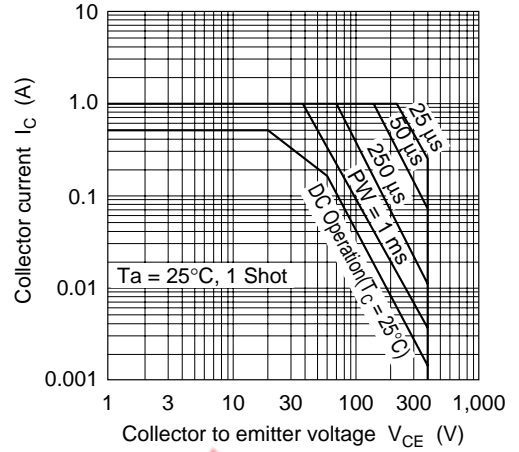
Item	Symbol	Min	Typ	Max	Unit	Test conditions
Collector to emitter sustain voltage	$V_{CEO(sus)}$	400	—	—	V	$I_C = 0.1\text{ A}$, $R_{BE} = \infty$ $L = 100\text{ mH}$
Emitter to base breakdown voltage	$V_{(BR)EBO}$	10	—	—	V	$I_E = 10\text{ mA}$, $I_C = 0$
Collector cutoff current	I_{CBO}	—	—	20	μA	$V_{CB} = 400\text{ V}$, $I_E = 0$
	I_{CEO}	—	—	50		$V_{CE} = 350\text{ V}$, $R_{BE} = \infty$
DC current transfer ratio	h_{FE1}	12	—	—		$V_{CE} = 5\text{ V}$, $I_C = 0.25\text{ A}^{*1}$
	h_{FE2}	5	—	—		$V_{CE} = 5\text{ V}$, $I_C = 0.5\text{ A}^{*1}$
Collector to emitter saturation voltage	$V_{CE(sat)}$	—	—	1.0	V	$I_C = 0.25\text{ A}$, $I_B = 0.05\text{ A}^{*1}$
Base to emitter saturation voltage	$V_{BE(sat)}$	—	—	1.5	V	$I_C = 0.25\text{ A}$, $I_B = 0.05\text{ A}^{*1}$
Turn on time	t_{on}	—	—	1.0	μs	$I_C = 0.5\text{ A}$, $I_{B1} = -I_{B2} = 0.1\text{ A}$,
Storage time	t_{stg}	—	—	2.0	μs	$V_{CC} \cong 150\text{ V}$
Fall time	t_f	—	—	1.0	μs	

Note: 1. Pulse test.

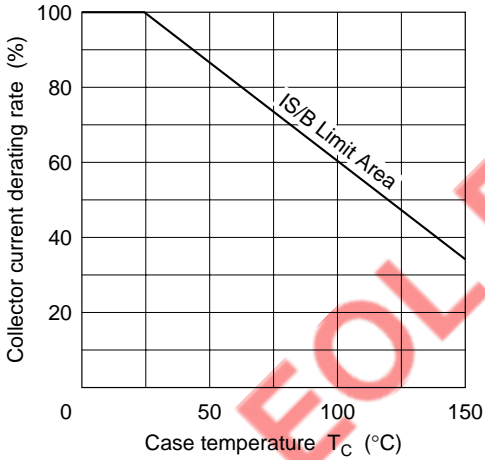
Maximum Collector Dissipation Curve



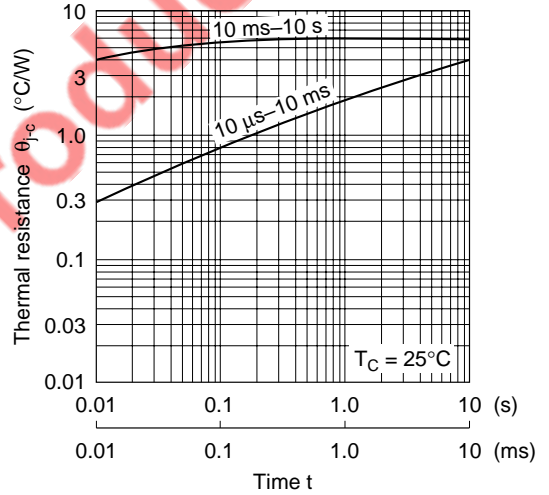
Area of Safe Operation

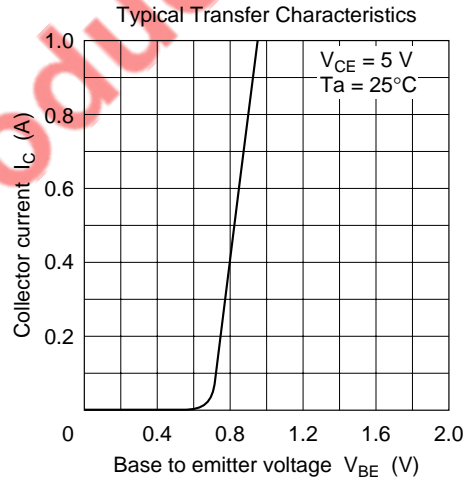
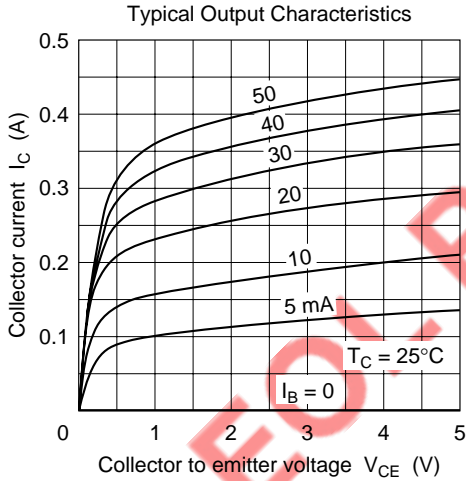
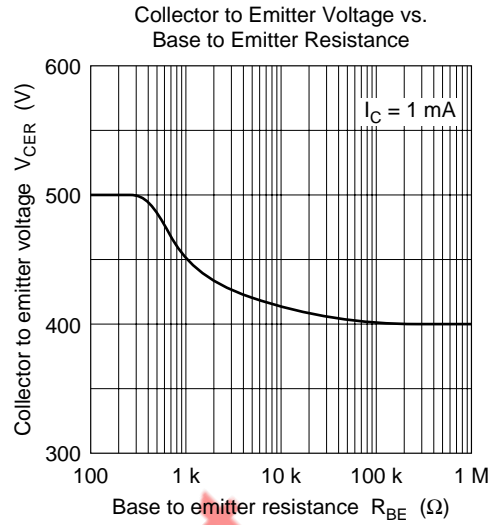
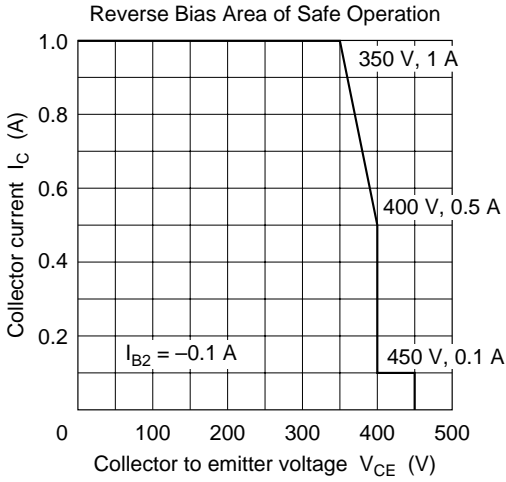


Collector Current Derating Rate

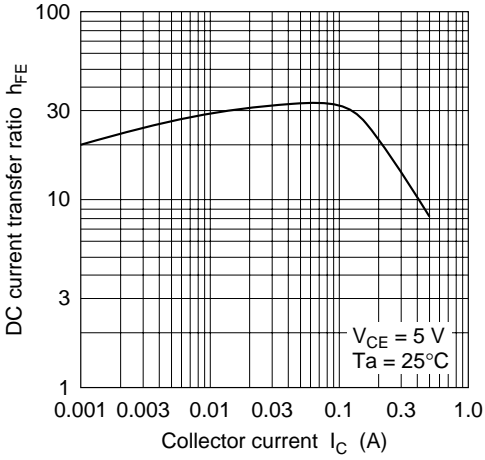


Transient Thermal Resistance

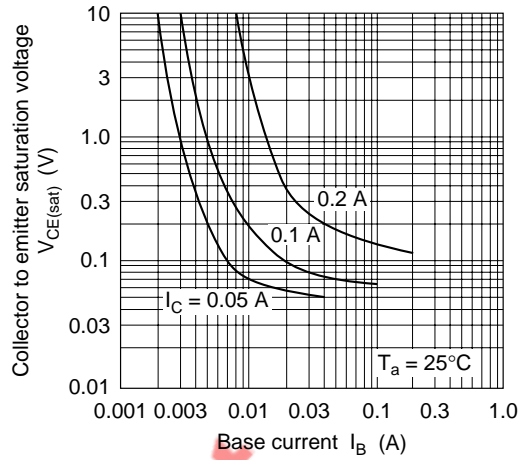




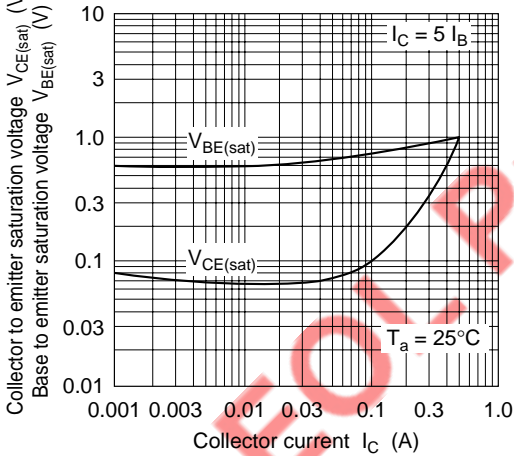
DC Current Transfer Ratio vs. Collector Current



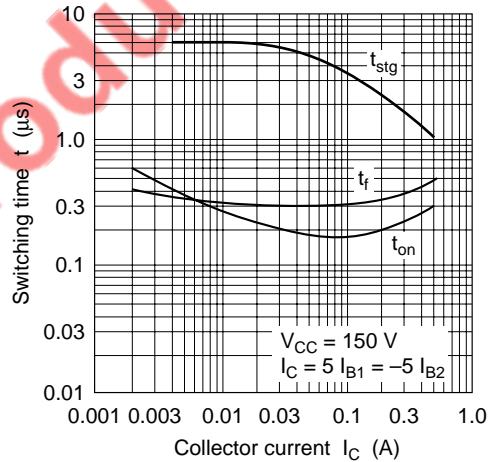
Collector to Emitter Saturation Voltage vs. Base Current

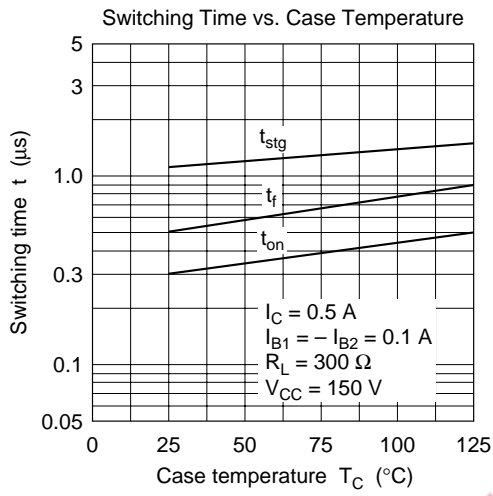


Saturation Voltage vs. Collector Current



Switching Time vs. Collector Current





EOL Product

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